



iPhoneXS MAX Chip Teardowns report Teardown

With English subtitles

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The cover features a central image of the iPhone XS MAX logic board with the A12 Bionic chip being worked on by a soldering iron. The chip is labeled 'A12' and '11K2R4025H-1834'. The background is dark with various text elements in Chinese and English.

iPhone X^S

iPhoneXS MAX

芯片拆

八核心

最高达
50%
图形处理器速度提升

最高达
15%
性能核心速度提升

最高达
50%
能效核心节能⁴

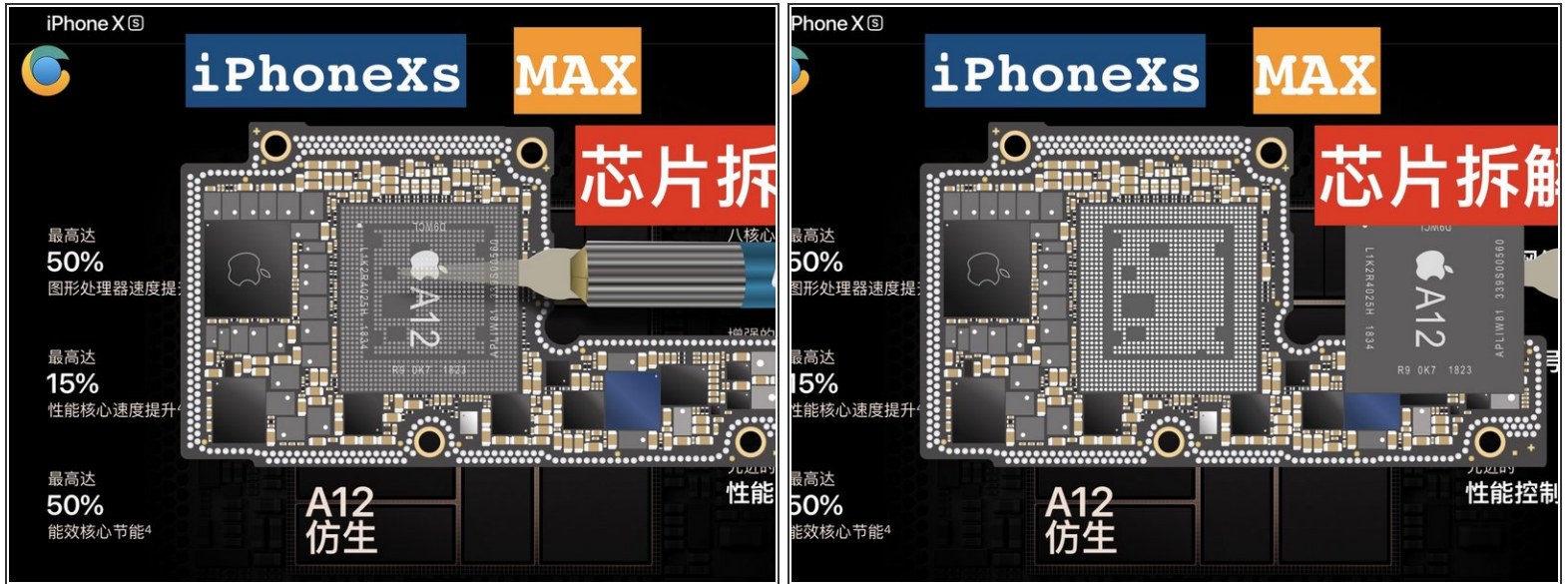
A12
仿生

性能

介绍

[video: <https://youtu.be/R0KypvOK4iM>]

步骤 1 — iPhoneXS MAX Chip Teardowns report Teardown



- Fix starts with teardowns

当重新组装你的设备时，请按照说明的相反顺序进行操作。

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